

REMARKS

Claims 1-6 are pending herein. By this Preliminary Amendment, claim 1 has been amended and new claims 5 and 6 have been added. Claim 1 has been amended to delete the language "as essential components,". New claims 5 and 6 are directed to methods of encapsulating semiconductors using the epoxy resin compositions of claims 1 and 2, respectively. Support for new claims 5 and 6 can be found in the specification at, for example, page 11, lines 3-8.

Respectfully submitted,
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